

Time dependent mechanics in metallic MEMS

Citation for published version (APA): Bergers, L. I. J. C., Hoefnagels, J. P. M., & Geers, M. G. D. (2009). *Time dependent mechanics in metallic* MEMS. Poster session presented at Mate Poster Award 2009 : 14th Annual Poster Contest.

Document status and date: Published: 01/01/2009

Document Version:

Publisher's PDF, also known as Version of Record (includes final page, issue and volume numbers)

Please check the document version of this publication:

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• The final published version features the final layout of the paper including the volume, issue and page numbers.

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1. Introduction

Creep and fatigue failure of metals in radio-frequency micro-electromechanical systems (RF-MEMS) impede their reliable application [1, 2]. Micro-scale studies of these mechanisms are scarce [3].

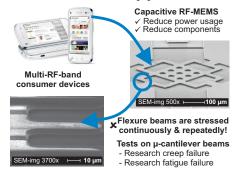


Figure 1: An exemplary application of RF-MEMS.

2. Objective

- Develop a method to characterize creep behavior of μm-sized aluminum MEMS cantilevers.
- Correlate this behavior to statistics of grain size, orientation and boundaries.

3. Methods

- A numeric-experimental method is developed for mechanical characterization, see fig. 2.
- Grain structure characterization is done with orientation imaging microscopy (OIM) utilizing electron backscatter diffraction.



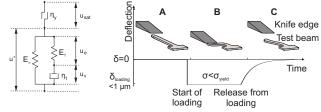


Figure 2: (I) A finite element model of the exact beam geometry based on a standard-solid visco-elastic material model is used to extract parameters from experimental data of creep behavior. (r) Schematic of the experiment in which a micro-manipulated knife edge deflects a cantilever. A confocal optical profilometer captures the deflection δ as function of time.

4. Results

Section Mechanics of Materials

• Numeric-experimental parameter characterization yields 20% accurate determination of time constant, see fig. 3.

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• Preliminary OIM maps indicate great variation in grain sizes and boundary orientations, see fig. 4.

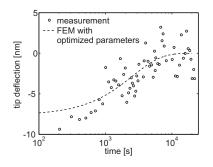


Figure 3: Resulting prediction by FEM of a different experiment based on material parameters determined from a previous measurement.

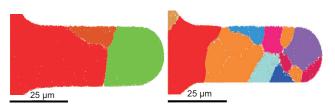


Figure 4: Grains in cantilever beams visualized by OIM maps for a specimen containing (I) few grains and (r) many grains. The colors indicate different grains.

5. Future work

• Investigate size-effects: correlate grain texture and statistics to observed behavior using OIM.

Norman Delhey is thanked for his significant contribution during his master's thesis.

References

- [1] W.M. van Spengen, Microelectronics Reliability 43, (2003) 1049-1060
- [2] G. Dehm, C. Motz, et.al., Advanced Engineering Materials 8 (2006) 1033-1045
- [3] T. Connolley, P. E. McHugh, M. Bruzzi, Fatigue Fract. Eng Mater. Struct. 28, (2005) 1119-1152